

# **4V Drive Nch MOSFET**

## RSJ10HN06

#### Structure

Silicon N-channel MOSFET

#### Features

- 1) Low on-resistance.
- 2) Built-in G-S Protection Diode.
- 3) High power Package

#### Application

Switching

Packaging specifications

	Package	Taping
Type	Code	TL
	Basic ordering unit (pieces)	1000
RSJ10HN0	0	

#### •Absolute maximum ratings $(T_a = 25^{\circ}C)$

Parameter		Symbol	Limits	Unit
Drain-source voltage		$V_{DSS}$	60	V
Gate-source voltage		$V_{GSS}$	<u>+20</u>	V
Drain current	Continuous	I <sub>D</sub> *3	±100	Α
	Pulsed	I <sub>DP</sub> *1	±200	Α
Source current	Continuous	I <sub>S</sub> *3	100	Α
(Body Diode)	Pulsed	I <sub>SP</sub> *1	200	Α
Power dissipation		P <sub>D</sub> *2	100	W
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg -55 to +150		°C

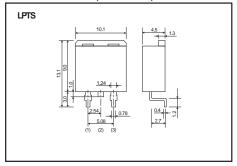
<sup>\*1</sup> Pw≤10µs, Duty cycle≤1%

#### • Thermal resistance

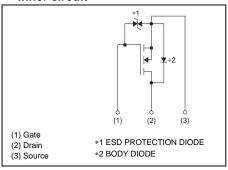
Parameter	Symbol	Limits	Unit
Channel to Case	Rth (ch-c)*	1.25	°C/W

<sup>\*</sup> T<sub>C</sub>=25°C

#### • Dimensions (Unit : mm)



#### • Inner circuit



<sup>\*2</sup> T<sub>C</sub>=25°C

<sup>\*3</sup> Limited only by maximum channel temperature allowed.

# ●Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I <sub>GSS</sub>		-	±10	μA	$V_{GS}=\pm20V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	60	1	-	>	I <sub>D</sub> =1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	I <sub>DSS</sub>	1	-	1	μA	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	1.0	-	2.5	V	$V_{DS}$ =10V, $I_{D}$ =1mA
Static drain-source on-state	R *	1	3.0	4.2	mΩ	I <sub>D</sub> =50A, V <sub>GS</sub> =10V
resistance	R <sub>DS (on)</sub>	1	3.5	4.9		I <sub>D</sub> =50A, V <sub>GS</sub> =4V
Forward transfer admittance	IY <sub>fs</sub> I*	60	-	-	S	V <sub>DS</sub> =10V, I <sub>D</sub> =50A
Input capacitance	C <sub>iss</sub>	1	11000	-	pF	V <sub>DS</sub> =10V
Output capacitance	Coss	1	2000	-	рF	V <sub>GS</sub> =0V
Reverse transfer capacitance	C <sub>rss</sub>	1	1050	-	рF	f=1MHz
Turn-on delay time	t <sub>d(on)</sub> *	1	50	-	ns	V <sub>DD</sub> ≒30V, I <sub>D</sub> =50A
Rise time	t <sub>r</sub> *	1	470	-	ns	V <sub>GS</sub> =10V
Turn-off delay time	t <sub>d(off)</sub> *	1	420	-	ns	$R_L=0.6\Omega$
Fall time	t <sub>f</sub> *	1	710	-	ns	$R_G=10\Omega$
Total gate charge	Q <sub>g</sub> *	-	202	-	nC	V <sub>DD</sub> ≒30V, I <sub>D</sub> =50A
Gate-source charge	Q <sub>gs</sub> *	-	35	-	nC	V <sub>GS</sub> =10V
Gate-drain charge	Q <sub>gd</sub> *	-	42	-	nC	

<sup>\*</sup>Pulsed

## ●Body diode characteristics (Source-Drain)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward Voltage	V <sub>SD</sub> *	-	-	1.5	V	I <sub>s</sub> =100A, V <sub>GS</sub> =0V

<sup>\*</sup>Pulsed

#### ●Electrical characteristic curves (Ta=25°C)

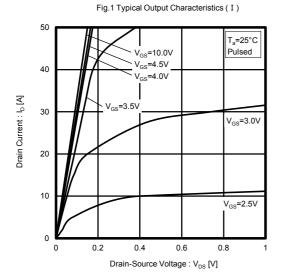


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current

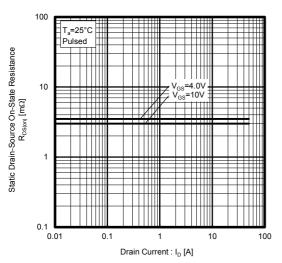


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

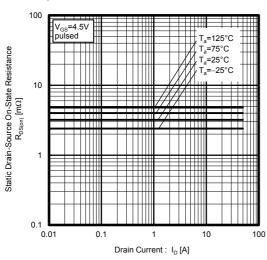


Fig.2 Typical Output Characteristics ( II )

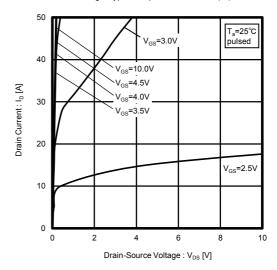


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current

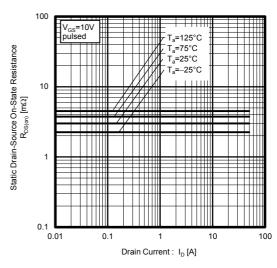


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current

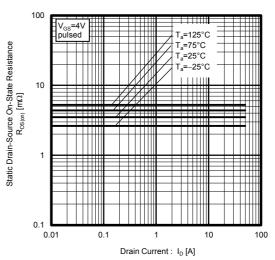


Fig.7 Forward Transfer Admittance vs. Drain Current

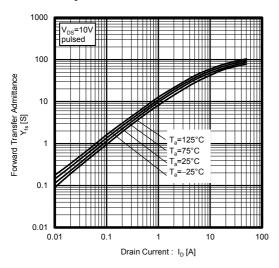


Fig.9 Source Current vs. Source-Drain Voltage

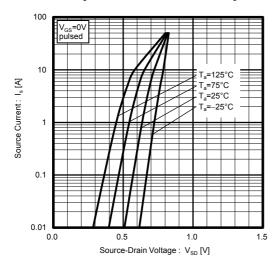


Fig.11 Switching Characteristics

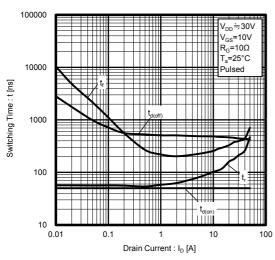


Fig.8 Typical Transfer Characteristics

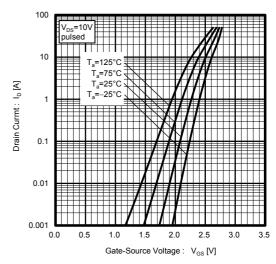


Fig.10 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

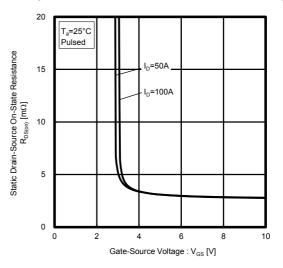
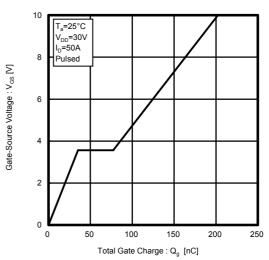


Fig.12 Dynamic Input Characteristics



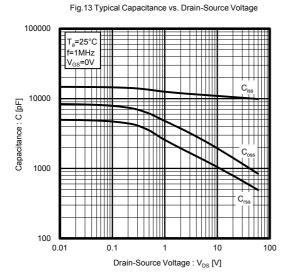
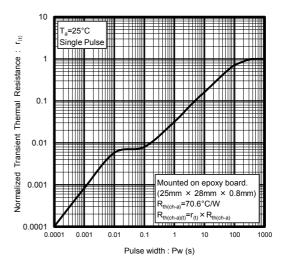


Fig.14 Normalized Transient Thermal Resistance v.s. Pulse Width



## ●Electrical characteristics (T<sub>a</sub> = 25°C)

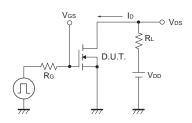


Fig.1-1 Switching Time Measurement Circuit

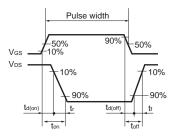


Fig.1-2 Switching Waveforms

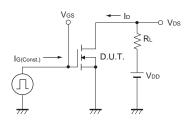


Fig.2-1 Gate Charge Measurement Circuit

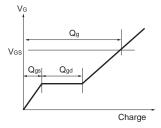


Fig.2-2 Gate Charge Waveform

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